

APPLICATION FOR LETTERS PATENT OF THE UNITED STATES

James F. Caruba

George W. Dailey

Fred E. Macciocchi

John P. Valenta

HIGH VOLTAGE DISTRIBUTION FOR A
RADIOGRAPHIC SENSOR DEVICE

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To Whom It May Concern:
THE FOLLOWING IS A SPECIFICATION OF THE AFORESAID
INVENTION

HIGH VOLTAGE DISTRIBUTION FOR A RADIOGRAPHIC SENSOR DEVICE

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The present invention relates generally to electrical power supply distribution, and more particularly to a high voltage distribution system for a radiographic sensor device such as a solid state gamma radiation imaging detector.

2. Description of the Background Art

[0002] Radiographic imaging is the detection of radiation from a distributed radiation field in order to form an image. By detecting the amount of radiation emanating from a test subject, the resultant image may give a representative view of the structure of the test subject.

[0003] Radiographic imaging typically employs gamma rays. Gamma rays are a form of radiation that is emitted by excited atomic nuclei during the process of passing to a lower excitation state. Gamma radiation is commonly used for medical imaging, and is capable of passing through soft tissue and bone. Gamma radiation may be provided by a radiopharmaceutical, such as thallium or technetium, for example, that is administered to the patient. The radiopharmaceutical travels through the patient's body and may be chosen to be absorbed or retained by an organ of interest. The radiopharmaceutical generates a predictable

emission of gamma rays through the patient's body that can be detected and used to create an image.

[0004] A radiographic imaging device may be used to detect radiation emanating from the patient and may be used to form an image or images for viewing and diagnosis. Conventional gamma cameras utilize a scintillation crystal (usually made of sodium iodide) which absorbs the gamma photon emissions and emits light photons (or light events) in response to the gamma absorption. An array of photodetectors, such as photomultiplier tubes, is positioned adjacent to the crystal. The photomultiplier tubes receive the light photons from the crystal and produce electrical signals having amplitudes corresponding to the amount of light photons received. The electrical signals from the photomultiplier tubes are applied to position computing circuitry, wherein the location of the light event is determined, and the event location is then stored in a memory, from which an image of the radiation field can be displayed or printed.

[0005] Also known in the art are solid-state nuclear imaging cameras, see, e.g., U.S. Patent Nos. 4,292,645 and 5,132,542. Such cameras use solid-state or semiconductor detector arrays in place of the scintillation crystal and photomultiplier tubes. In a solid-state camera, gamma rays are absorbed in a semiconductor material, creating electron-hole pairs in the semiconductor material. A bias voltage across the semiconductor detector

causes the electrons and holes to form an electric current through the semiconductor material. The currents are converted by associated circuitry into electrical signals, which are processed to determine the location and magnitude of the gamma ray absorption event. While solid-state cameras offer potential benefits over the conventional scintillation crystal cameras in terms of reduced weight, improved resolution, improved uniformity, and increased imaging area, the use of such cameras has presented its own set of problems. In particular, early solid-state detectors made of germanium had to be cryogenically cooled to achieve acceptable performance.

[0006] Semiconductor detectors made of cadmium zinc telluride (CZT) have recently been proposed for use in solid-state gamma cameras. Such detectors may be operated at room temperature.

[0007] A number of radiographic sensor device modules may be tiled in an array to form a detector head. The detector head may be formed such that the radiographic sensor modules are individually detachable for maintenance, adjustment, etc.

[0008] The electrical signals generated by each component radiographic sensor device must be communicated to a processor or other device for interpretation, manipulation, and storage. Therefore, each radiographic sensor device must include a wiring harness to communicate the electrical signals to a processor of some sort. For the sensor array, the electrical connection is

typically done through a pin grid array, having an array of pins corresponding to the sensor elements. However, the sensor elements generally output low voltages and are fairly simple to connect.

[0009] The electrical power supply provided to a cathode of each radiographic sensor device is typically a high negative voltage. The high voltage supplied to the cathode is used to control the current induced in the semiconductor material as a result of gamma interaction. Typically, the electrical power has been provided in the prior art by simple wire or trace connections, such as for example, a metal cathode substrate layer formed on the detector and connected to an electrical supply by wires or cables.

[0010] In the prior art the electrical power supply connection to the cathode has been problematic. The electrical power voltage level may be relatively high. Therefore, the prior art conductor connecting the cathode to an electrical power supply must be relatively large. In addition, for purposes of maintenance and repair, it is desirable that individual radiographic sensor devices be capable of being disconnected and reconnected without the necessity of disassembling the entire detector array. It is imperative that this be accomplished without compromising the electrical connection. Therefore, the electrical power supply path must be capable of self-alignment and a guaranteed contact.

[0011] What is needed, therefore, are improvements in high voltage distribution for solid-state radiographic detector devices.

SUMMARY OF THE INVENTION

[0012] An electrical power distribution system adapted for use with a cathode of a radiographic sensor device of a radiographic imaging device is provided according to the invention. The distribution system comprises an insulated conductor formed on a first detector portion of the radiographic imaging device and communicating electrical power to the cathode. The distribution system further comprises an intermediate conduction portion communicating with the insulated conductor. The intermediate conduction portion includes a contact surface. The distribution system further comprises a separable interconnect extending from a second detector portion of the radiographic imaging device. The separable interconnect communicates with an electrical power source and is positioned to come into contact with the intermediate conduction portion when the first detector portion of the radiographic imaging device is assembled to the second detector portion.

[0013] A method of providing electrical power to a cathode of a radiographic sensor device of a radiographic imaging apparatus is provided according to the invention. The method comprises the step of providing an insulated conductor on a first detector

portion of the radiographic sensor device. The insulated conductor communicates electrical power to the cathode. The method further comprises the step of providing an intermediate conduction portion communicating with the insulated conductor. The intermediate conduction portion includes a contact surface. The method further comprises the step of providing a separable interconnect extending from a second detector portion of the radiographic imaging device. The separable interconnect communicates with an electrical power source and is positioned to come into contact with the intermediate conduction portion when the first detector portion is assembled to the second detector portion. When the first detector portion of the radiographic sensor device is assembled to the second detector portion, the separable interconnect removably contacts the intermediate conduction portion and conducts electrical power to the intermediate conduction portion and therefore to the insulated conductor and the cathode.

[0014] The above and other features and advantages of the present invention will be further understood from the following description of the preferred embodiments thereof, taken in conjunction with the accompanying drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

[0015] FIG. 1 shows an electrical power distribution system for a radiographic sensor device; and

[0016] FIG. 2 is a flow chart of one method embodiment for providing electrical power to a cathode of a radiographic sensor device.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0017] FIG. 1 shows a high voltage distribution system for a radiographic sensor device 100. The high voltage distribution system includes a semiconductor detector 112 (such as CZT), a PC board 103, a separable interconnect 145, an intermediate conduction portion 137, an insulated conductor 133, and a cathode 119. In addition, the electrical power distribution system may include a pin grid array 128, a socket array 106 (which may also be a circuit board), an optional biasing device 149, and a signal board 114 (containing sensors and any associated circuitry).

[0018] For purposes of maintenance, repair, and even configuration or calibration, the radiographic sensor device may be separated into a first detector portion 160 and a second signal processing portion 170, as shown. The first detector portion 160 may be an imaging device component that incorporates the semiconductor detector 112, sensors, and any attendant components such as a pin grid array 128, etc.

[0019] The second signal processing portion 170 may comprise one or more circuit boards and one or more socket arrays to receive one or more associated first detector portions 160. The

circuit boards and socket array shown may be a portion of an overall circuit board 103 and socket array 106 for receiving a plurality of first detector portions 160. The second signal processing portion 170 may therefore be part of a detector head of a radiographic imaging apparatus.

[0020] One or more first detector portions 160 may be assembled to the second signal processing portion 170 to form a completed detector head. When assembled, one or more first detector portions mate with the second signal processing portion 170 --(and an associated pin grid array 128 mates with a corresponding portion of the socket array 106).

[0021] The separable interconnect 145 extends from the second signal processing portion 170 (and with respect to the circuit board 103). Therefore, when assembled, the separable interconnect 145 contacts and is biased against the intermediate conduction portion 137. The separable interconnect 145 therefore maintains physical and electrical contact with the intermediate conduction portion 137 and electrical power is conducted from the second signal processing portion 170 to the intermediate conduction portion 137, the insulated conductor 133, and ultimately to the cathode 119.

[0022] The separable interconnect 145 provides a connectorless mechanical separability and a mechanical flexibility. Therefore, the radiographic sensor device 100 is relatively insensitive to

misalignment, whereby the first detector portion 160 may be installed on the second signal processing portion 170 without undue concern for maintaining a proper alignment of the separable interconnect 145. This results in a radiographic detector that is easier to assemble, easier to maintain, and requires less operator attention. Furthermore, a higher level of accuracy and reliability may be achieved due to the reliable electrical power distribution according to the invention.

[0023] In one embodiment, the separable interconnect 145 is deformable. Therefore, the assembly of the detector head causes the separable interconnect 145 to deform when it contacts the intermediate conduction portion 137. The deformation of the separable interconnect 145 creates a biasing force that keeps the separable interconnect 145 in contact with the intermediate conduction portion 137.

[0024] In another embodiment, the separable interconnect 145 is positioned in an aperture 146 in the circuit board 103. The separable interconnect 145 therefore is slidable within the circuit board 103 and accordingly is movable with respect to the second signal processing portion 170. The separable interconnect 145 is biased away from the second signal processing portion 170 by the biasing device 149. A biasing force is exerted by the biasing device 149 in order to displace the separable

interconnect 145 outward and away from the second signal processing portion 170.

[0025] The biasing device 149 may be any type of device that creates a biasing force. The biasing device 149 may be a spring, such as a coil or leaf spring. Alternatively, the separable interconnect 145 may be a bladder, diaphragm, or other biasing device. The separable interconnect 145 is therefore capable of maintaining an electrical connection by maintaining a bias force against the intermediate conduction portion 137.

[0026] The biasing device 149 is shown as being positioned on the underside of the circuit board 103, but may be located at any suitable position with respect to the separable interconnect 145.

[0027] The separable interconnect 145 according to the invention is advantageous in that it may allow the first detector portion 160 to move laterally by a first predetermined distance with respect to the second signal processing portion 170, without losing electrical connection. The first predetermined distance is substantially the surface area of the intermediate conduction portion 137. In addition, the separable interconnect 145 is advantageous in that it may allow the first detector portion 160 to move a second predetermined distance with respect to the second signal processing portion 170. The second predetermined distance is substantially a range of travel of the separable interconnect 145 (controlled by the biasing device 149 or by the

deformation properties of the separable interconnect 145), while maintaining contact with the intermediate conduction portion 137.

[0028] FIG. 2 is a flow chart 200 of one method embodiment for providing electrical power to a cathode of a radiographic sensor device. In step 204, an insulated conductor is provided, with the insulated conductor being in electrical communication with the cathode.

[0029] In step 208, an intermediate conduction portion is provided, with the intermediate conduction portion communicating with the insulated conductor. The intermediate conduction portion includes a contact surface suitable for mechanical and electrical contact with a separable interconnect. The insulated conductor and the intermediate conduction portion are formed on a first detector portion that may be removably assembled to a detector head of a radiographic imaging device.

[0030] In step 213, a separable interconnect is provided. The separable interconnect extends from the second signal processing portion. The separable interconnect may be deformable in order to maintain a contact pressure against the first detector portion when assembled to the first detector portion. Alternatively, the separable interconnect may movably extend from the second signal processing portion and be movable with respect to the second signal processing portion. The separable interconnect communicates with an electrical power source (not shown) and is

positioned so as to come into contact with the intermediate conduction portion when the first detector portion is assembled to the second signal processing portion.

[0031] In step 215, the separable interconnect is biased away from the second detection portion. The biasing may be performed by deforming the separable interconnect when assembling the first detector portion to the second signal processing portion. Alternatively, the biasing may be performed by a biasing device communicating with the separable interconnect.

[0032] Therefore, when the first detector portion is assembled to the second signal processing portion, the separable interconnect removably contacts the intermediate conduction portion. As a result, the separable interconnect provides electrical power to the intermediate conduction portion, to the insulated conductor, and to the cathode (i.e., to the first detector portion). In this manner, electrical power, such as a high negative voltage, may be provided to the radiographic sensor device, while providing an interconnect that is substantially independent of alignment and is relatively compact.

[0033] While the invention has been described in detail above, the invention is not intended to be limited to the specific embodiments as described. It is evident that those skilled in the art may now make numerous uses and modifications of and

departures from the specific embodiments described herein without departing from the inventive concepts.

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